

□ MN101C70C

Type	MN101C70C	MN101CF70D
Internal ROM type	Mask ROM	FLASH
ROM (byte)	48K	64K
RAM (byte)	2K	4K
Package (Lead-free)	LQFP080-P-1414A, TQFP080-P-1212D (Under planning)	LQFP080-P-1414A (Under development), TQFP080-P-1212D (Under planning)
Minimum Instruction Execution Time	0.1 μs (at 3.0 V to 3.6 V, 10 MHz) 0.235 μs (at 1.8 V to 3.6 V, 4.25 MHz) 62.5 μs (at 1.8 V to 3.6 V, 32 kHz)	0.25 μs (at 3.0 V to 3.6 V, 8 MHz) 0.50 μs (at 2.28 V to 3.6 V, 4 MHz) 62.5 μs (at 2.2 V to 3.6 V, 32 kHz)

■ Interrupts

RESET, Watchdog, External 0 to 2, External 4 (key interrupt dedicated), Timer 0 to 3, Timer 6, Timer 7 (2 systems), Timer 8 (2 systems), Time base, Serial 0 (2 systems), Serial 2, A/D conversion finish, Automatic transfer finish

■ Timer Counter

Timer counter 0 : 8-bit × 1

(square-wave/8-bit PWM output, event count, generation of remote control carrier, simple pulse width measurement, added pluse

(2-bit) system PWM output, real time output control)

(square-wave/PWM output to large current terminal P50 possible)

Clock source..... 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input

Interrupt source coincidence with compare register 0

Timer counter 1 : 8-bit × 1

(square-wave output, event count, synchronous output event, serial transfer clock output)

Clock source..... 1/2, 1/8 of system clock frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input

Interrupt source coincidence with compare register 1

Timer counter 0, 1 can be cascade-connected.

Timer counter 2 : 8-bit × 1

(square-wave output, added pluse (2-bit) system PWM output, PWM output, serial transfer clock output, real time output control, event count, synchronous output event, simple pulse width measurement)

(square-wave/PWM output to large current terminal P52 possible)

Clock source..... 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input

Interrupt source coincidence with compare register 2

Timer counter 3 : 8-bit × 1

(square-wave output, event count, generation of remote control carrier, serial transfer clock)

Clock source..... 1/2, 1/8 of system clock frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input

Interrupt source coincidence with compare register 3

Timer counter 2, 3 can be cascade-connected.

Timer counter 6 : 8-bit freerun timer

Clock source..... 1/1 of system clock frequency; 1/1, 1/128, 1/8192 of OSC oscillation clock frequency; 1/1, 1/128, 1/8192 of XI oscillation clock frequency

Interrupt source coincidence with compare register 6

Timer counter 7 : 16-bit × 1

(square-wave output, 16-bit PWM output (cycle / duty continuous variable), event count, synchronous output event, pulse width measurement, input capture, real time output control, high performance IGBT output (Cycle/Duty can be changed constantly))

(square-wave/PWM output to large current terminal P51 possible)

Clock source..... 1/1, 1/2, 1/4, 1/16 of system clock frequency; 1/1, 1/2, 1/4, 1/16 of OSC oscillation clock frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency

Interrupt source coincidence with compare register 7 (2 lines), input capture register

Timer counter 8 : 16 bit × 1

(square-wave/16-bit PWM output [duty continuous variable], event count, pulse width measurement, input capture)(square-wave/PWM output to large current terminal P53 possible)

Clock source..... 1/1, 1/2, 1/4, 1/16 of system clock frequency; 1/1, 1/2, 1/4, 1/16 of OSC oscillation clock frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency

Interrupt source coincidence with compare register 8 (2 lines), input capture register

Timer counters 7, 8 can be cascade-connected. (square-wave output, PWM is possible as a 32-bit timer.)

Time base timer (one-minute count setting)

Clock source..... 1/1 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency

Interrupt source 1/128, 1/256, 1/512, 1/1024, 1/8192, 1/32768, of clock source frequency

Watchdog timer

Interrupt source 1/65536, 1/262144, 1/1048576 of system clock frequency

■ **Serial interface**

Serial 0 : synchronous type/UART (full-duplex) × 1

Clock source..... 1/2, 1/4 of system clock frequency; pulse output of timer counter 2 or 3; 1/2, 1/4, 1/16, 1/64 of OSC oscillation clock frequency, external clock

Serial 2 : synchronous type/single-master I²C × 1

Clock source..... 1/2, 1/4 of system clock frequency; pulse output of timer counter 2 or 3; 1/2, 1/4, 1/16, 1/32 of OSC oscillation clock frequency, external clock

■ **DMA controller**

Max. Transfer cycles : 255

Starting factor : external request, various types of interrupt, software

Transfer mode : 1-byte transfer, word transfer, burst transfer

■ **I/O Pins**

I/O	66	Common use , Specified pull-up resistor available, Input/output selectable (bit unit)
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■ **A/D converter**

10-bit × 16-ch. (with S/H)

■ **Display control function**

LCD

32 segments × 4 commons (static, 1/2, 1/3, or 1/4 duty)

LCD power supply separated from VDD (usable if VDD ≤ VLCD ≤ 3.6 V)

LCD power step-up circuit contained (3/2, 2 and 3 times)

LCD power shunt resistance contained

LCD reference voltage is contained.

■ **Special Ports**

Buzzer output, remote control carrier signal output, high-current drive port

■ **ROM Correction**

Correcting address designation : up to 3 addresses possible

■ **Electrical Characteristics (Supply current)**

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	
Operating supply current	IDD1	fosc = 4 MHz , VDD = 3 V		1	1.8	mA
	IDD2	fx = 32 kHz , VDD = 3 V		4	15	μA
Supply current at HALT	IDD3	fx = 32 kHz , VDD = 3 V , Ta = 25°C		2	5	μA
	IDD4	fx = 32 kHz , VDD = 3 V , Ta = -40°C to +85°C			10	μA
Supply current at STOP	IDD5	VDD = 3 V , Ta = 25°C			2	μA
Supply current at STOP	IDD6	VDD = 3 V , Ta = -40°C to +85°C			8	μA

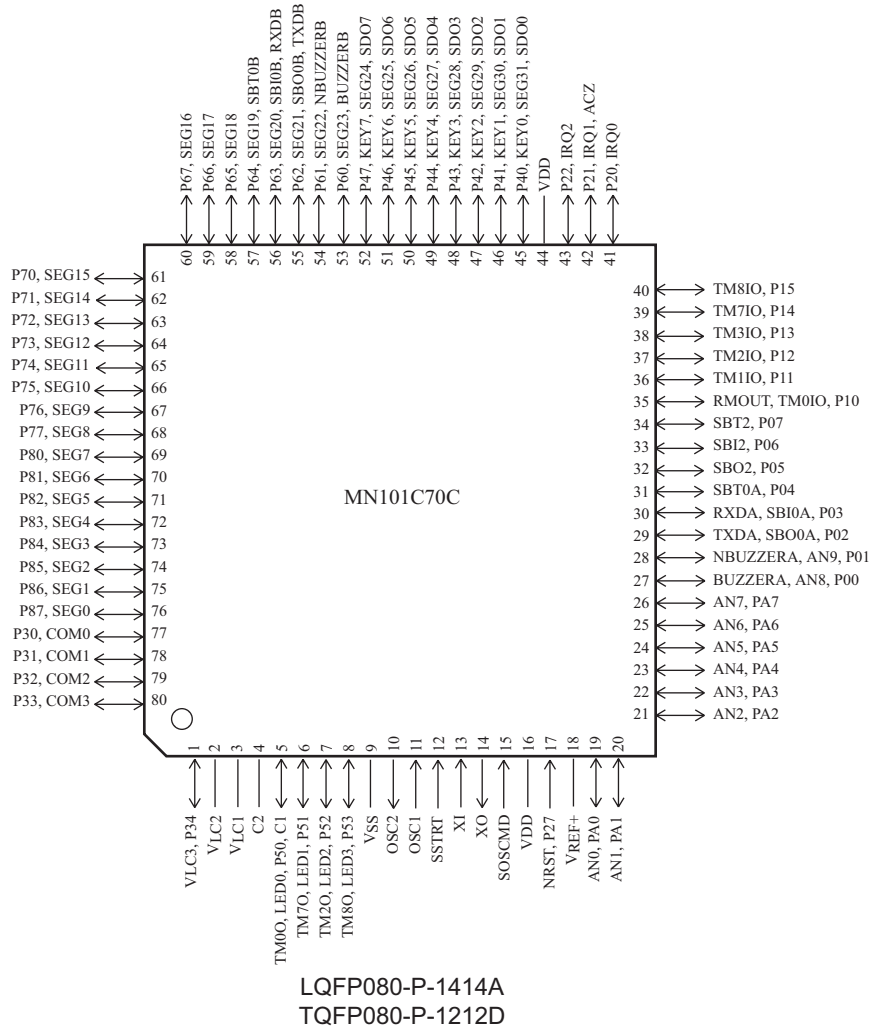
■ Development tools

In-circuit Emulator

PX-ICE101C/D+PX-PRB101C70-LQFP080-P-1414A-M

PX-ICE101C/D+PX-PRB101C70-TQFP080-P-1212-M

■ Pin Assignment



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